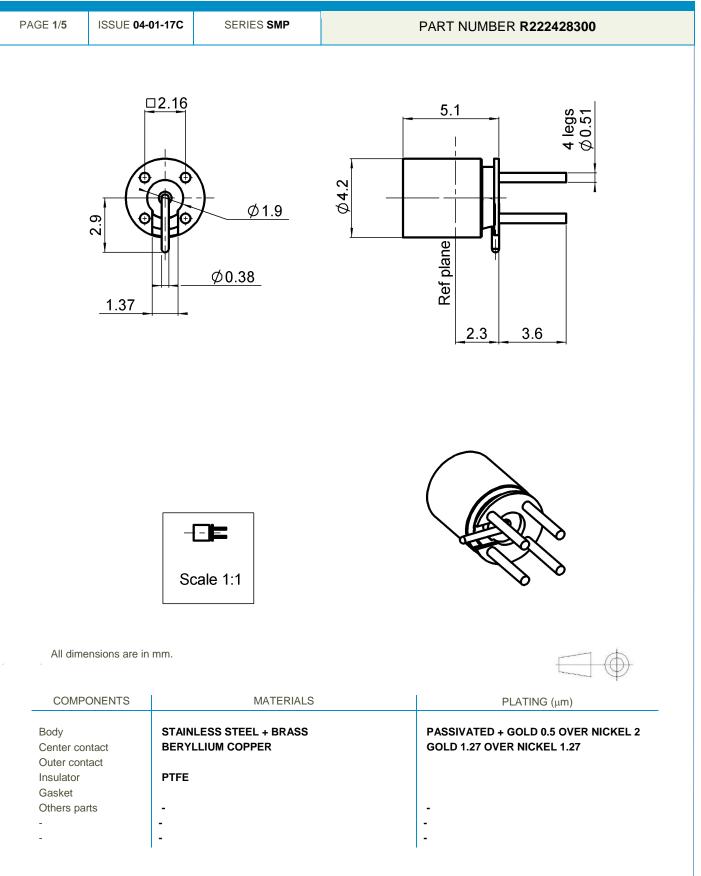
Technical Data Sheet

STRAIGHT JACK RECEPTACLE PIN IN PASTE - LIMITED DETENT



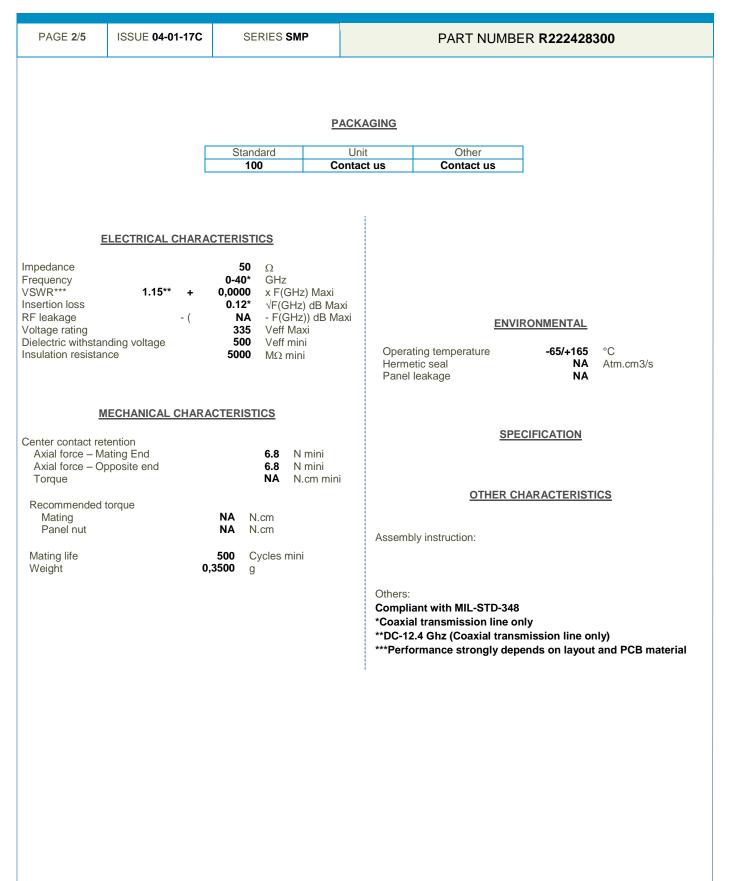


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Technical Data Sheet

STRAIGHT JACK RECEPTACLE PIN IN PASTE - LIMITED DETENT





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STRAIGHT JACK RECEPTACLE PIN IN PASTE - LIMITED DETENT

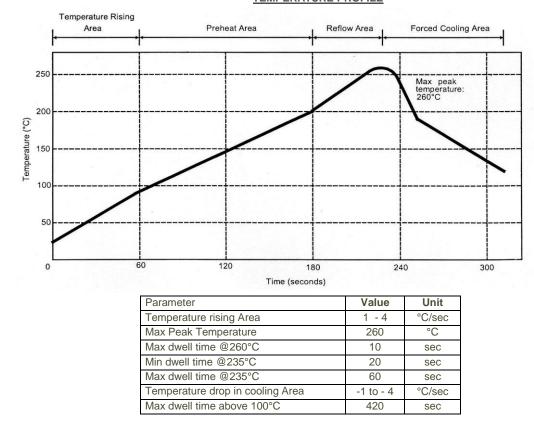
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ISSUE 04-01-17C SERIES SMP

PART NUMBER R222428300

SOLDER PROCEDURE

- Deposition of solder paste 'Sn Ag4 Cu0.5' on mounting zone by screen printing application. We recommend a low residue flux. We advise a thickness of 150 microns (5.85 microinch). Verify that the edges of the zone are clean.
- Placement of the receptacle on the mounting zone with an automatic machine of 'pick and place' type.
 Video camera is recommended for the positioning of the component. Adhesive agents must not be used on the receptacle.
- Soldering by infra-red reflow. Below, please find the typical profile to use.
- 4. Cleaning of printed circuit boards.
- 5. Checking of solder joints and position of the component by visual inspection.



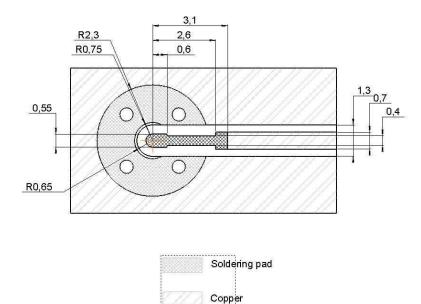
TEMPERATURE PROFILE

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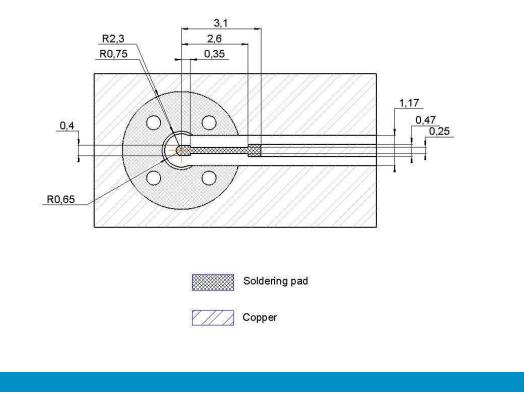


RECOMMENDED PAD DIMENSIONS:

Substrate: RT5880 thickness 0.254mm, with copper layer 35µm on both sides : Add vias between both sides along upper ground plane according to engineering practise



Substrate: RO4350 thickness 0.254mm, with copper layer 35µm on both sides : Add vias between both sides along upper ground plane according to engineering practise

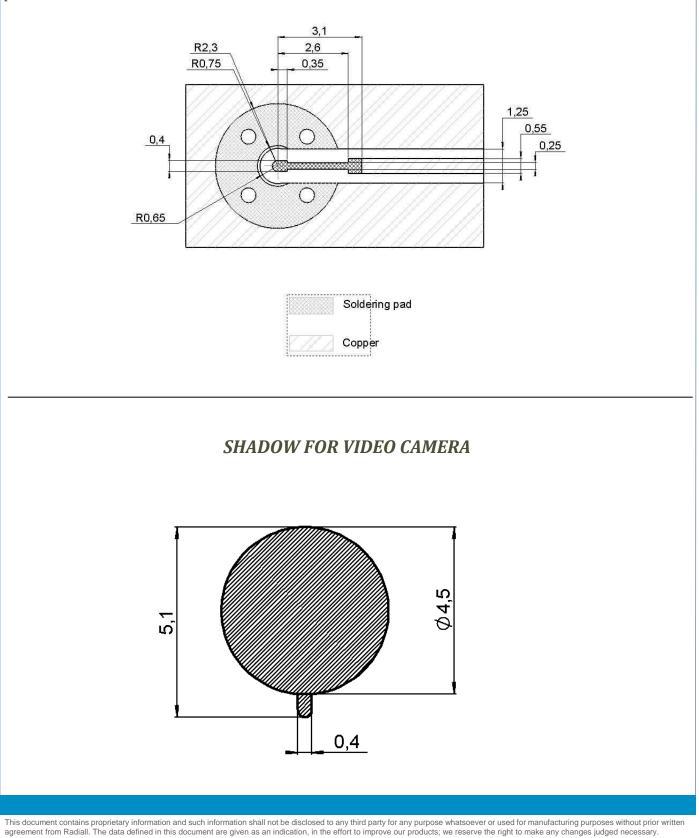


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Substrate: RO6002 thickness 0.254mm, with copper layer 35µm on both sides :

Add vias between both sides along upper ground plane according to engineering practise



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